

5 GHz Wideband NPN Chip – BFR91

Silicon NPN Planar RF Transistor in bare die form

Rev 1.1 3/11/17

Description

NPN transistor in unencapsulated chip form. It is primarily intended for use in RF wideband amplifiers, such as in aerial amplifiers, radar systems, oscilloscopes, spectrum analyzers, etc. The transistor features low intermodulation distortion and high power gain; due to its very high transition frequency, it also has excellent wideband properties and low noise up to high frequencies. PNP complement is BFT92.

Ordering Information

The following part suffixes apply:

- No suffix MIL-STD-750 /2072 Visual Inspection
- "H" MIL-STD-750 /2072 Visual Inspection+ MIL-PRF-38534 Class H LAT
- "K" MIL-STD-750 /2072 Visual Inspection
 + MIL-PRF-38534 Class K LAT

LAT = Lot Acceptance Test.

For further information on LAT process flows see below.

www.siliconsupplies.com\quality\bare-die-lot-qualification

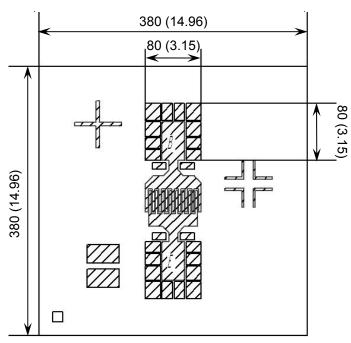
Supply Formats:

- Default Die in Waffle Pack (400 per tray capacity)
- Sawn Wafer on Tape By specific request
- Unsawn Wafer By specific request
- With additional electrical selection Specific request
- Sawn as pairs or adjacent pair pick Specific request

Features:

- High Power Gain
- Low Noise
- Wide Transition Frequency

Die Dimensions in µm (mils)



B = BASE, E = EMITTER
CHIP BACKSIDE IS COLLECTOR

Mechanical Specification

380 x 380 14.96 x 14.96	μm mils	
80 x 80	μm	
3.15 x 3.15	mils	
240 (±20) 9.45 (±0.78)	μm mils	
Au 1.5μm		
Au 0.35μm		
	14.96 x 14.96 80 x 80 3.15 x 3.15 240 (±20) 9.45 (±0.78) Au 1.5µm	





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Absolute Maximum Ratings T_A = 25°C unless otherwise stated

SYMBOL	PARAMETER	CONDITIONS	MIN	MAX	UNIT
V_{CBO}	collector-base voltage	open emitter	-	20	V
V _{CEO}	collector-emitter voltage	open base	-	15	V
V_{EBO}	emitter-base voltage	open collector	-	2	V
I _C	DC collector current	-	-	50	mA
P _{tot}	total power dissipation	-	-	300	mW
T _{stg}	storage temperature	-	-65	150	°C
T _J	junction temperature	-	-	175	°C

Electrical Characteristics TA = 25°C

SYMBOL	PARAMETER	CONDITIONS	MIN	TYP	MAX	SYMBOL
I _{CBO}	collector cut-off current	I _E = 0 ; V _{CB} = 20V	-	-	100	nA
h _{FE}	DC current gain	$I_{C} = 30 \text{mA}; V_{CE} = 5 \text{V}$	25	50	150	
f _T	transition frequency	I _C = 30mA; V _{CE} = 5V; f = 300 MHz	-	5	-	GHz
G_P	power gain	$I_C = 30$ mA; $V_{CE} = 5$ V; $f = 800$ MHz	-	13	-	dB
NF	noise figure	I _C = 2mA; V _{CE} = 5V; f = 500 MHz	-	1.9	-	dB

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